

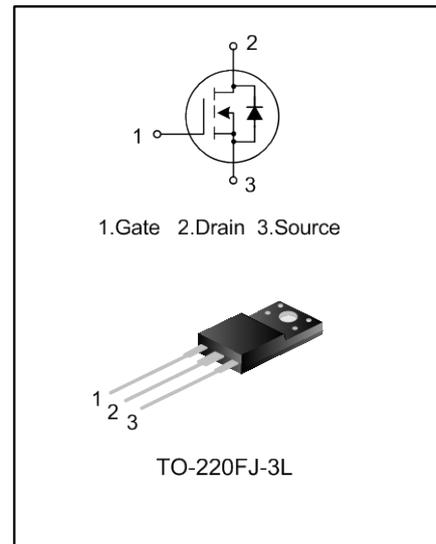
7A, 650V N-CHANNEL MOSFET

GENERAL DESCRIPTION

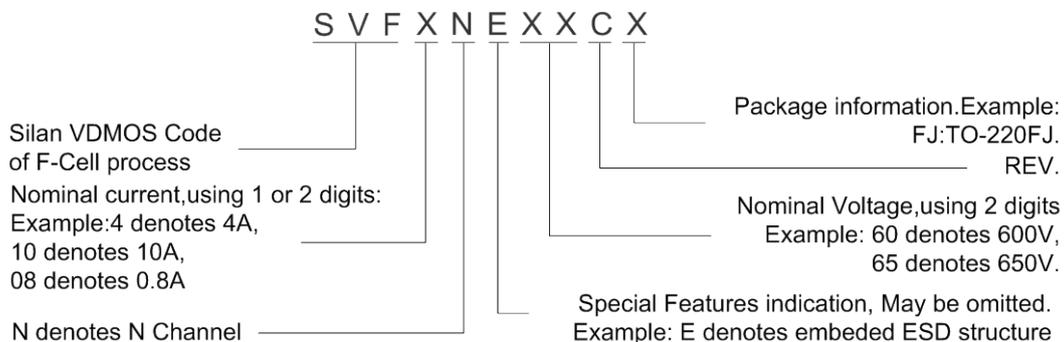
SVF7N65CFJ is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.

FEATURES

- ◆ 7A, 650V, $R_{DS(on)(typ.)}=1.1\Omega @ V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low Crss
- ◆ Fast switching
- ◆ Improved dv/dt capability



NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing
SVF7N65CFJ	TO-220FJ-3L	7N65CFJ	Halogen free	Tube

ABSOLUTE MAXIMUM RATINGS (T_C=25°C unless otherwise noted)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		V _{DS}	650	V
Gate-Source Voltage		V _{GS}	±30	V
Drain Current	T _C = 25°C	I _D	7.0	A
	T _C = 100°C		4.4	
Drain Current Pulsed		I _{DM}	28	A
Power Dissipation(T _C =25°C) -Derate above 25°C		P _D	46	W
			0.37	W/°C
Single Pulsed Avalanche Energy (Note 1)		E _{AS}	435	mJ
Operation Junction Temperature Range		T _J	-55~+150	°C
Storage Temperature Range		T _{stg}	-55~+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	2.7	°C/W
Thermal Resistance, Junction-to-Ambient	R _{θJA}	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_C=25°C unless otherwise noted)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	650	--	--	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V	--	--	1.0	μA
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _D =250μA	2.0	--	4.0	V
Static Drain- Source On State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =3.5A	--	1.1	1.4	Ω
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHZ	--	789	--	pF
Output Capacitance	C _{oss}		--	98	--	
Reverse Transfer Capacitance	C _{rss}		--	9.0	--	
Turn-on Delay Time	t _{d(on)}	V _{DD} =325V, R _G =25Ω, I _D =7.0A (Note 2,3)	--	15.0	--	ns
Turn-on Rise Time	t _r		--	32.0	--	
Turn-off Delay Time	t _{d(off)}		--	51.0	--	
Turn-off Fall Time	t _f		--	32.5	--	
Total Gate Charge	Q _g	V _{DS} =520V, I _D =7.0A, V _{GS} =10V (Note 2,3)	--	21.2	--	nC
Gate-Source Charge	Q _{gs}		--	4.53	--	
Gate-Drain Charge	Q _{gd}		--	10.2	--	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_S	Integral Reverse P-N Junction	--	--	7.0	A
Pulsed Source Current	I_{SM}	Diode in the MOSFET	--	--	28.0	
Diode Forward Voltage	V_{SD}	$I_S=7.0A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=7.0A, V_{GS}=0V,$	--	499	--	ns
Reverse Recovery Charge	Q_{rr}	$di_F/dt=100A/\mu S$ (Note 2)	--	3.0	--	μC

Notes:

1. $L=30mH, I_{AS}=5.0A, V_{DD}=100V, R_G=25\Omega,$ starting $T_J=25^\circ C;$
2. Pulse Test: Pulse width $\leq 300\mu s,$ Duty cycle $\leq 2\%;$
3. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

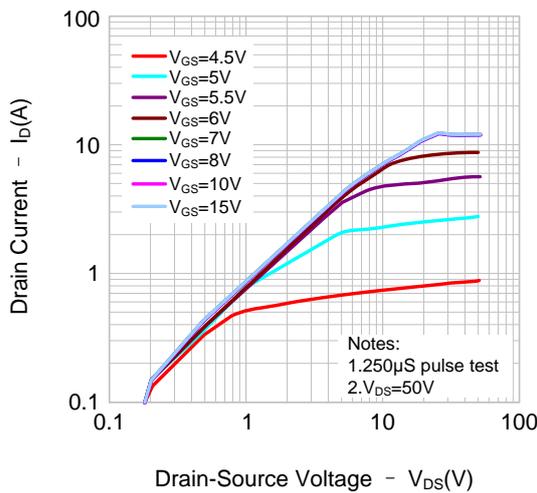


Figure 2. Transfer Characteristics

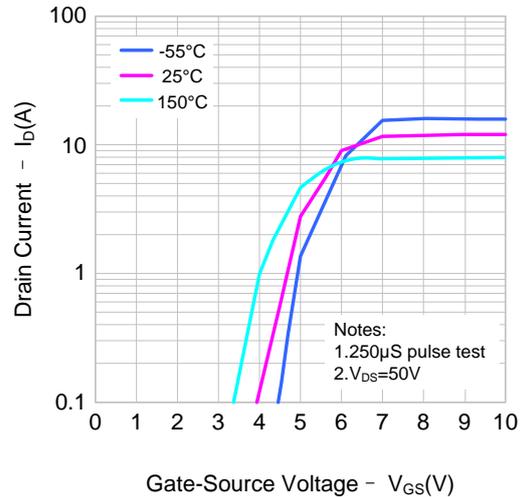


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

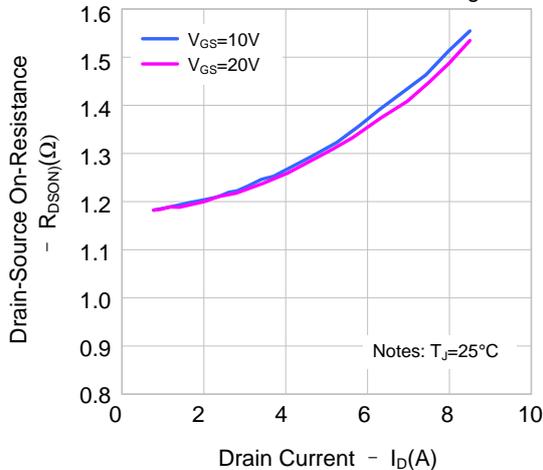
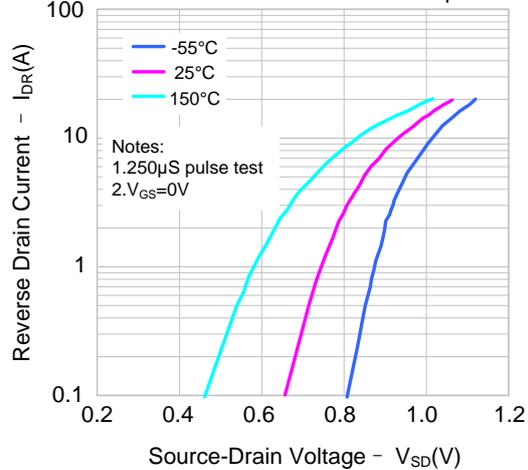


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL CHARACTERISTICS (continued)

Figure 5. Capacitance Characteristics

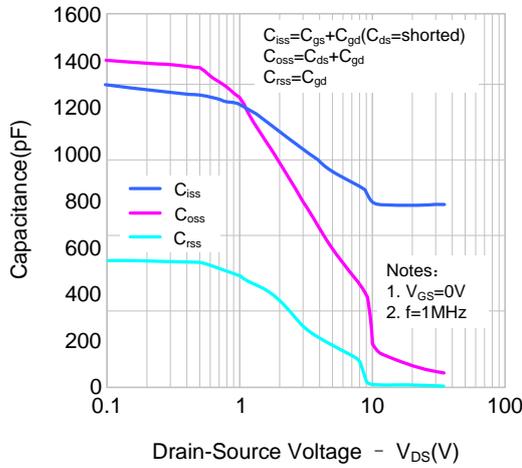


Figure 6. Gate Charge Characteristics

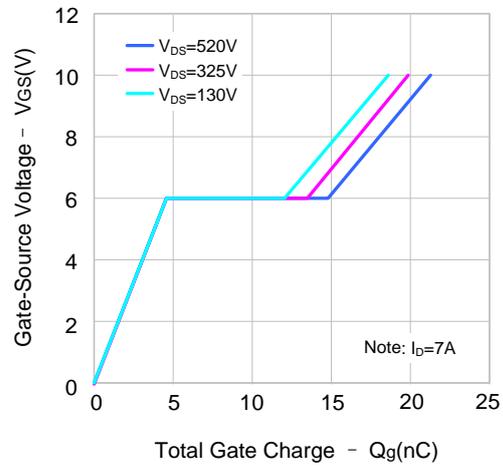


Figure 7. Breakdown Voltage Variation vs. Temperature

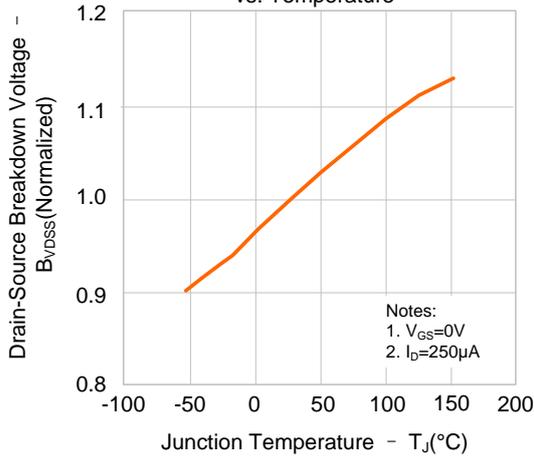


Figure 8. On-resistance Variation vs. Temperature

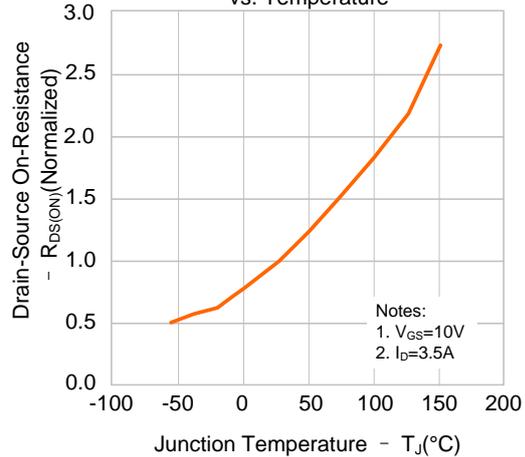


Figure 9. Max. Safe Operating Area

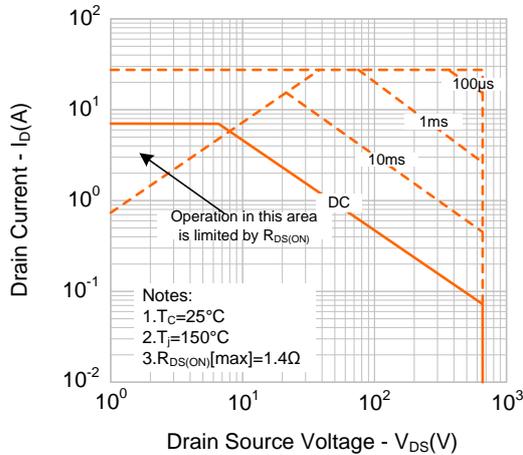
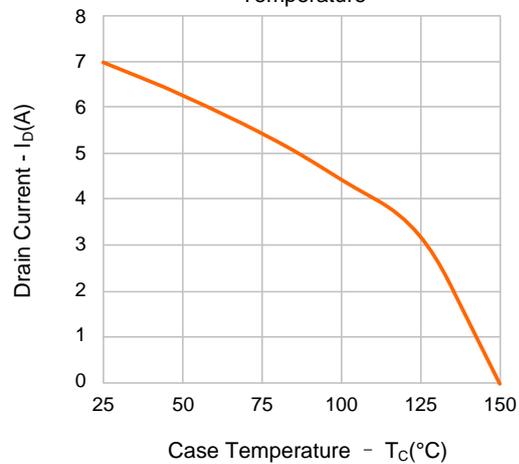
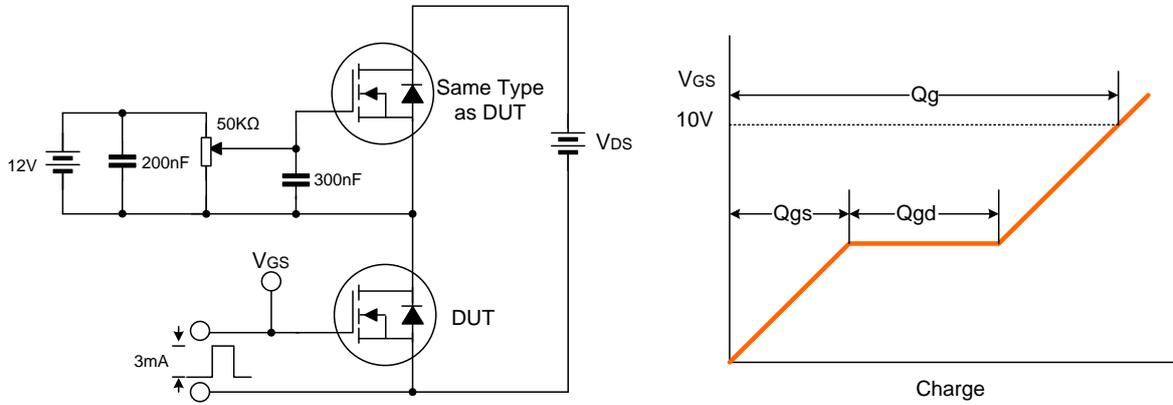


Figure 10. Max. Drain Current vs. Case Temperature

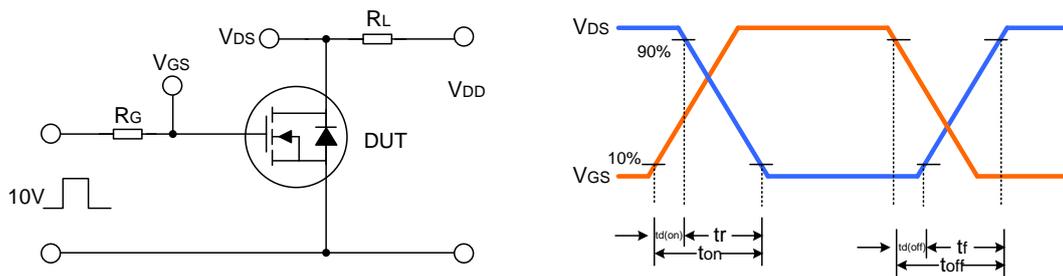


TYPICAL TEST CIRCUIT

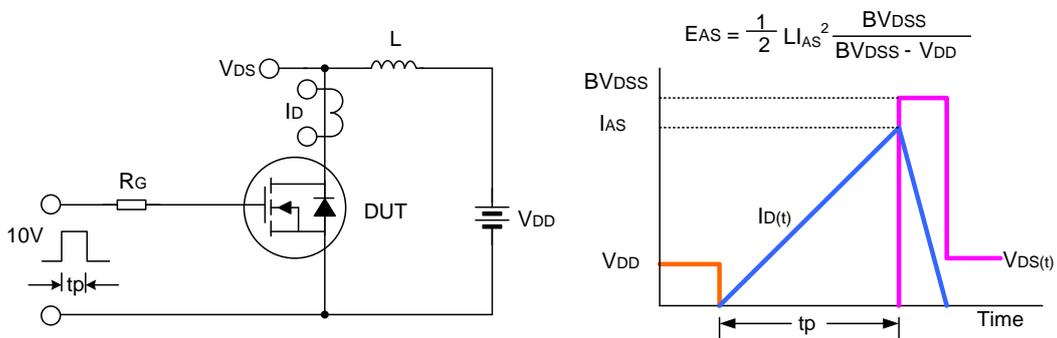
Gate Charge Test Circuit & Waveform



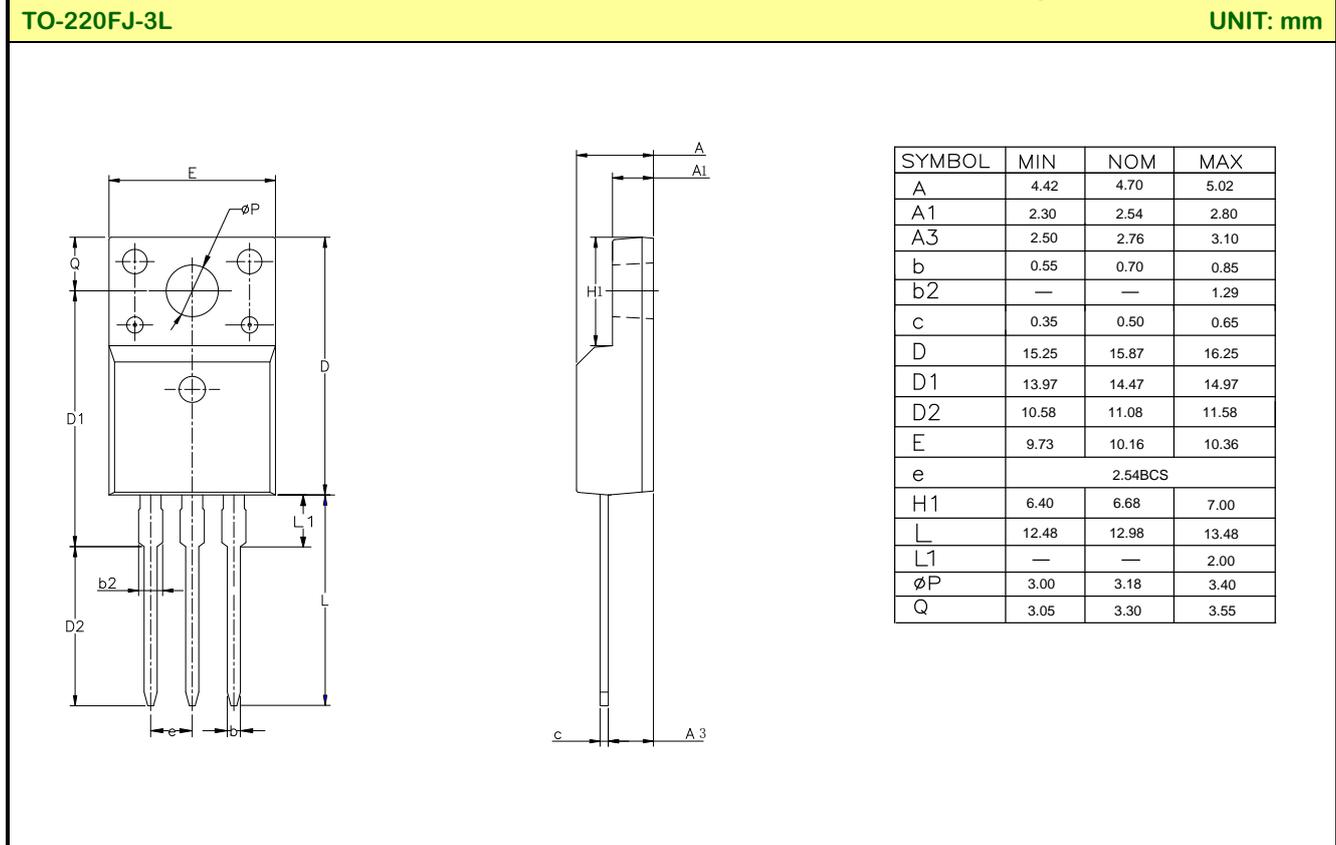
Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE



Disclaimer :

- Silan reserves the right to make changes to the information herein for the improvement of the design and performance without prior notice! Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
- All semiconductor products malfunction or fail with some probability under special conditions. When using Silan products in system design or complete machine manufacturing, it is the responsibility of the buyer to comply with the safety standards strictly and take essential measures to avoid situations in which a malfunction or failure of such Silan products could cause loss of body injury or damage to property.
- Silan will supply the best possible product for customers!

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Rev.: 1.4

Revision History:

1. Modify the Typical Characteristics Fig1-5
 2. Update description
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Rev.: 1.3

Revision History:

1. Modify the Typical Characteristics
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Rev.: 1.2

Revision History:

1. Modify the package information of TO-220FJ-3L
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Rev.: 1.1

Revision History:

1. Modify the thermal characteristics
-

Rev.: 1.0

Revision History:

1. First release
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